## Automotive ultrafast recovery diode

Datasheet - production data


## Features

- Very low conduction losses
- Negligible switching losses
- Low forward and reverse recovery times
- High junction temperature
- PPAP capable
- AEC-Q101 qualified


## Description

This device uses ST's new 200 V planar Pt doping technology, and it is especially suited for switching mode base drive and transistor circuits.

Packaged in SMB, SMC and DPAK, it is intended for use in low voltage, high frequency inverters, freewheeling and polarity protection in automotive applications.

Table 1: Device summary

| Symbol | Value |
| :---: | :---: |
| $\mathrm{I}_{\mathrm{F}(\mathrm{AV})}$ | 4 A |
| $\mathrm{~V}_{\text {RRM }}$ | 200 V |
| $\mathrm{~T}_{\mathrm{j}}$ (max.) | $175^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\mathrm{F}}$ (typ.) | 0.76 V |
| $\mathrm{t}_{\text {rr }}$ (typ.) | 16 ns |

## 1

Characteristics
Table 2: Absolute ratings (limiting values at $25^{\circ} \mathrm{C}$, unless otherwise specified)

| Symbol | Parameter |  |  | Value | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| VRRM | Repetitive peak reverse voltage |  | $\mathrm{T}_{\mathrm{j}}=-40^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ | 200 | V |
| $\mathrm{IF}_{\text {(RMS })}$ | Forward rms current |  |  | 10 | A |
| $\mathrm{If}_{\text {( }} \mathrm{AV}$ ) | Average forward current $\delta=0.5$, square wave | DPAK | $\mathrm{T}_{\mathrm{c}}=160^{\circ} \mathrm{C}$ | 4 | A |
|  |  | SMB, SMC | $\mathrm{T}_{\text {lead }}=95^{\circ} \mathrm{C}$ |  |  |
| Ifsm | Surge non repetitive forward current | $\mathrm{t}_{\mathrm{p}}=10 \mathrm{~ms}$ sinusoidal |  | 70 | A |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range |  |  | -65 to +175 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{j}}$ | Maximum operating junction temperature ${ }^{(1)}$ |  |  | -40 to +175 | ${ }^{\circ} \mathrm{C}$ |

## Notes:

${ }^{(1)}\left(\mathrm{dPtot} / \mathrm{dT}_{\mathrm{j}}\right)<\left(1 / \mathrm{Rth}_{\mathrm{th}}(-\mathrm{a})\right)$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 3: Thermal parameters

| Symbol | Parameter |  | Maximum | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{R}_{\mathrm{th}(j-\mathrm{c})}$ | Junction to case | DPAK | 3.5 | $\mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\mathrm{th}(-\mathrm{l})}$ | Junction to lead | SMB, SMC | 20 |  |

Table 4: Static electrical characteristics

| Symbol | Parameter | Test c | ditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{R}}{ }^{(1)}$ | Reverse leakage current | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | $V_{R}=V_{\text {RRM }}$ | - |  | 3 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  | - | 2 | 20 |  |
| $\mathrm{VF}^{(2)}$ | Forward voltage drop | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | $\mathrm{IF}=4 \mathrm{~A}$ | - | 0.95 | 1.05 | V |
|  |  | $\mathrm{T}_{\mathrm{j}}=150^{\circ} \mathrm{C}$ |  | - | 0.76 | 0.83 |  |

## Notes:

${ }^{(1)}$ Pulse test: $\mathrm{t}_{\mathrm{p}}=5 \mathrm{~ms}, \delta<2 \%$
${ }^{(2)}$ Pulse test: $\mathrm{t}_{\mathrm{p}}=380 \mu \mathrm{~s}, \delta<2 \%$

To evaluate the conduction losses use the following equation:
$\mathrm{P}=0.67 \times \mathrm{I}_{\mathrm{F}(\mathrm{AV})}+0.04 \mathrm{I}^{2}(\mathrm{RMS})$

Table 5: Dynamic characteristics

| Symbol | Parameters |  | est conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $t_{\text {rr }}$ | Reverse recovery time | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=1 \mathrm{~A} ; \mathrm{dl} / \mathrm{dt}=-50 \mathrm{~A} / \mu \mathrm{s} ; \\ & \mathrm{V}_{\mathrm{R}}=30 \mathrm{~V} \end{aligned}$ | - | 24 | 30 | ns |
|  |  |  | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=1 \mathrm{~A} ; \mathrm{dl}_{\mathrm{F}} / \mathrm{dt}=-100 \mathrm{~A} / \mu \mathrm{s} ; \\ & \mathrm{V}_{\mathrm{R}}=30 \mathrm{~V} \end{aligned}$ | - | 16 | 20 |  |
| IRM | Reverse recovery current | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=4 \mathrm{~A} ; \mathrm{dl}_{\mathrm{F}} / \mathrm{dt}=-200 \mathrm{~A} / \mu \mathrm{s} ; \\ & \mathrm{V}_{\mathrm{R}}=160 \mathrm{~V} \end{aligned}$ | - | 4.4 | 5.5 | A |
| trr | Reverse recovery time |  |  | - | 27 |  | ns |
| Qrr | Reverse recovery charges |  |  | - | 60 |  | nC |

### 1.1 Characteristics (curves)

Figure 1: Peak current versus duty cycle


Figure 2: Forward voltage drop versus forward current (typical values)


Figure 3: Forward voltage drop versus forward current (maximum values)


Figure 4: Relative variation of thermal impedance, junction to case, versus pulse duration


Figure 5: Relative variation of thermal impedance, junction to ambient, versus pulse duration (SMB)


Figure 6: Relative variation of thermal impedance, junction to ambient, versus pulse duration (SMC)


Figure 7: Junction capacitance versus reverse applied voltage (typical values)


Figure 8: Reverse recovery charges versus dIF/dt (typical values)


Figure 9: Reverse recovery time versus dIF/dt (typical values)


Figure 10: Peak reverse recovery current versus dIF/dt (typical values)


Figure 11: Dynamic parameters versus junction temperature


Figure 12: Thermal resistance, junction to ambient, versus copper surface under tab


Figure 13: Thermal resistance, junction to ambient, versus copper surface under each lead


Figure 14: Thermal resistance, junction to ambient, versus copper surface under each lead


## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK ${ }^{\circledR}$ packages, depending on their level of environmental compliance. ECOPACK ${ }^{\circledR}$ specifications, grade definitions and product status are available at: www.st.com. ECOPACK ${ }^{\circledR}$ is an ST trademark.

### 2.1 DPAK package information

Figure 15: DPAK package outline


Table 6: DPAK mechanical data

| Dim. | Millimeters |  |  |  |  | Inches |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Typ. |  |  | Max. | Min. | Typ. |
|  | Min. | Max. |  |  |  |  |
| A | 2.20 |  | 2.40 | 0.087 |  | 0.094 |
| A1 | 0.90 |  | 1.10 | 0.035 |  | 0.043 |
| A2 | 0.03 |  | 0.23 | 0.001 |  | 0.009 |
| b | 0.64 |  | 0.90 | 0.025 |  | 0.035 |
| b4 | 5.20 |  | 5.40 | 0.205 |  | 0.213 |
| c | 0.45 |  | 0.60 | 0.018 |  | 0.024 |
| c2 | 0.48 |  | 0.60 | 0.019 |  | 0.024 |
| D | 6.00 |  | 6.20 | 0.236 |  | 0.244 |
| D1 | 4.95 | 5.10 | 5.25 | 0.201 | 0.195 | 0.207 |
| E | 6.40 |  | 6.60 | 0.252 |  | 0.260 |
| E1 | 4.60 | 4.70 | 4.80 | 0.181 | 0.185 | 0.189 |
| e | 2.16 | 2.28 | 2.40 | 0.085 | 0.090 | 0.094 |
| e1 | 4.40 |  | 4.60 | 0.173 |  | 0.181 |
| H | 9.35 |  | 10.10 | 0.368 |  | 0.398 |
| L | 1.00 |  | 1.50 | 0.039 |  | 0.059 |
| (L1) | 2.60 | 2.80 | 3.00 | 0.102 | 0.110 | 0.118 |
| L2 | 0.65 | 0.80 | 0.95 | 0.026 | 0.031 | 0.037 |
| L4 | 0.60 |  | 1.00 | 0.024 |  | 0.039 |
| R |  | 0.20 |  |  | 0.008 |  |
| V2 | $0^{\circ}$ |  | $8^{\circ}$ | $0{ }^{\circ}$ |  | $8^{\circ}$ |

Figure 16: DPAK recommended footprint (dimensions are in mm)


### 2.2 SMC package information

Figure 17: SMC package outline


Table 7: SMC package mechanical data

| Ref. | Dimensions |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Millimeters |  | Inches |  |
|  | Min. | Max. | Min. | Max. |
| A1 | 1.90 | 2.45 | 0.0748 | 0.0965 |
| A2 | 0.05 | 0.20 | 0.0020 | 0.0079 |
| b | 2.90 | 3.20 | 0.1142 | 0.1260 |
| c | 0.15 | 0.40 | 0.0059 | 0.0157 |
| D | 5.55 | 6.25 | 0.2185 | 0.2461 |
| E | 7.75 | 8.15 | 0.3051 | 0.3209 |
| E1 | 6.60 | 7.15 | 0.2598 | 0.2815 |
| E2 | 4.40 | 4.70 | 0.1732 | 0.1850 |
| L | 0.75 | 1.50 | 0.0295 | 0.0591 |

Figure 18: SMC recommended Footprint


### 2.3 SMB package information

Figure 19: SMB package outline


Table 8: SMB package mechanical data

| Ref. | Dimensions |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Millimeters |  | Inches |  |
|  | Min. | Max. | Min. | Max. |
| A1 | 1.90 | 2.45 | 0.0748 | 0.0965 |
| A2 | 0.05 | 0.20 | 0.0020 | 0.0079 |
| b | 1.95 | 2.20 | 0.0768 | 0.0867 |
| C | 0.15 | 0.40 | 0.0059 | 0.0157 |
| D | 3.30 | 3.95 | 0.1299 | 0.1556 |
| E | 5.10 | 5.60 | 0.2008 | 0.2205 |
| E1 | 4.05 | 4.60 | 0.1594 | 0.1811 |
| L | 0.75 | 1.50 | 0.0295 | 0.0591 |

Figure 20: SMB recommended Footprint


## 3 Ordering information

Figure 21: Ordering information scheme


Table 9: Ordering information

| Order code | Marking | Package | Weight | Base qty. | Delivery mode |
| :---: | :---: | :---: | :---: | :---: | :---: |
| STTH4R02BY-TR | STTH4 R02BY | DPAK | 0.320 g | 2500 | Tape and reel |
| STTH4R02UY | 4R2UY | SMB | 0.110 g | 2500 | Tape and reel |
| STTH4R02SY | 4R2SY | SMC | 0.243 g | 2500 | Tape and reel |

## 4 Revision history

Table 10: Document revision history

| Date | Revision | Changes |
| :---: | :---: | :--- |
| 03-Dec-2010 | 1 | First issue |
|  | 2 | Added device in DPAK. <br> Updated features and description in cover page. <br> Updated Table 2: "Absolute ratings (limiting values at 25 ${ }^{\circ} \mathrm{C}$, unless <br> otherwise specified)", Table 3: "Thermal parameters" and Table 5: <br> "Dynamic characteristics". <br> 14-Apr-2016 |
| Updated Figure 2: "Forward voltage drop versus forward current <br> (typical values)" and Figure 3: "Forward voltage drop versus forward <br> current (maximum values)". <br> Updated Section 4: "Ordering information". |  |  |

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